

INFORMATION DISCLOSURE CITATION

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ATTY DOCKET NO.
END000006US1

SERIAL NO.
09/514,526

Donald S. Farquhar et al.

FILING
2/28/00

GROUP
1746

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
<i>PS</i>	3,539,408	11/1970	Cashau et al.			
<i>PS</i>	3,616,349	10/1971	Szupillo			
<i>PS</i>	3,630,795	12/1971	Vorie			
<i>PS</i>	5,641,391	6/1997	Hunter et al.			
<i>PS</i>	5,733,432	3/1998	Williams et al.			

DC600 U.S. PTO
09/514526
02/28/00

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

<i>PS</i>	IBM Technical Disclosure Bulletin, ETCHABILITY OF CHROMIUM FILMS, R. G. Frieser, Vol. 13, No. 4, September 1970
<i>PS</i>	ELECTROPLATING, Frederick A. Lowenheim, pages 27-45, Chapter 3-Corrosion, McGraw-Hill Book Company

EXAMINER

J. D. Metcalf

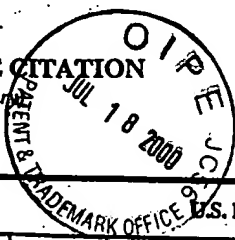
DATE CONSIDERED

10/16/01

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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Docket Number (Optional)

END920000006

Application Number

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Applicant(s)

Farquhar et al

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02/28/00

Group Art Unit

1746

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						

FOREIGN PATENT DOCUMENTS

REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation YES NO
AL						
AM						
AN						
AO						
AP						

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

AR	"High Performance Carrier Technology: Materials And Fabrication", by Light et al, 1993 International Electronics Packaging Conference, San Diego, California, Volume One.
AS	"High Performance Carrier Technology", by Heck et al, 1993 International Electronics Packaging Conference, San Diego, California, Volume One.

EXAMINER

[Signature]

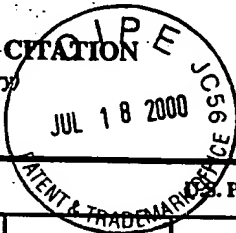
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	AN							
	AO							
	AP							

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

	AR	"Process Considerations in the Fabrication of Teflon Printed Circuit Boards", by Light et al, 1994 Proceedings, 44 Electronic Components & Technology Conference, 5/94.

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